MOSFET – Single, N-Channel, Small Signal, SOT-23 30 V, 0.56 A

Features

- Low Gate Voltage Threshold (V_{GS(TH)}) to Facilitate Drive Circuit Design
- Low Gate Charge for Fast Switching
- ESD Protected Gate
- SOT-23 Package Provides Excellent Thermal Performance
- Minimum Breakdown Voltage Rating of 30 V
- NVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Notebooks:
 - Level Shifters
 - Logic Switches
 - Low Side Load Switches
- Portable Applications

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	30	V		
Gate-to-Source Voltage			V _{GS}	±20	V		
Continuous Drain	Steady	$T_A = 25^{\circ}C$	۱ _D	0.5	А		
Current (Note 1)	State	T _A = 85°C		0.37			
Power Dissipation (Note 1)	Steady State		Steady State		P _D	0.69	W
Continuous Drain	t < 10 s	$T_A = 25^{\circ}C$	Ι _D	0.56	Α		
Current (Note 1)		T _A = 85°C		0.40			
Power Dissipation (Note 1)	t < 5 s		P _D	0.83	W		
Pulsed Drain Current	t _p =	10 μs	I _{DM}	1.7	А		
Operating Junction and Storage Temperature			TJ,	-55 to	°C		
			Tstg	150			
Source Current (Body Diode)			۱ _S	1.0	Α		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

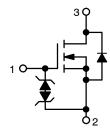


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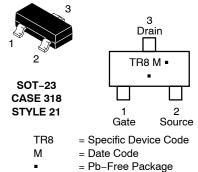
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V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX
30 V	1.0 Ω @ 4.0 V	0.56 A
00 1	1.5 Ω @ 2.5 V	0.0071





MARKING DIAGRAM/ PIN ASSIGNMENT



(Note: Microdot may be in either location)
*Date Code orientation and overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR4003NT1G	SOT–23 (Pb–Free)	3000 / Tape & Reel
NTR4003NT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel
NVR4003NT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	180	°C/W
Junction-to-Ambient - t < 10 s (Note 1)	$R_{\theta JA}$	150	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	300	

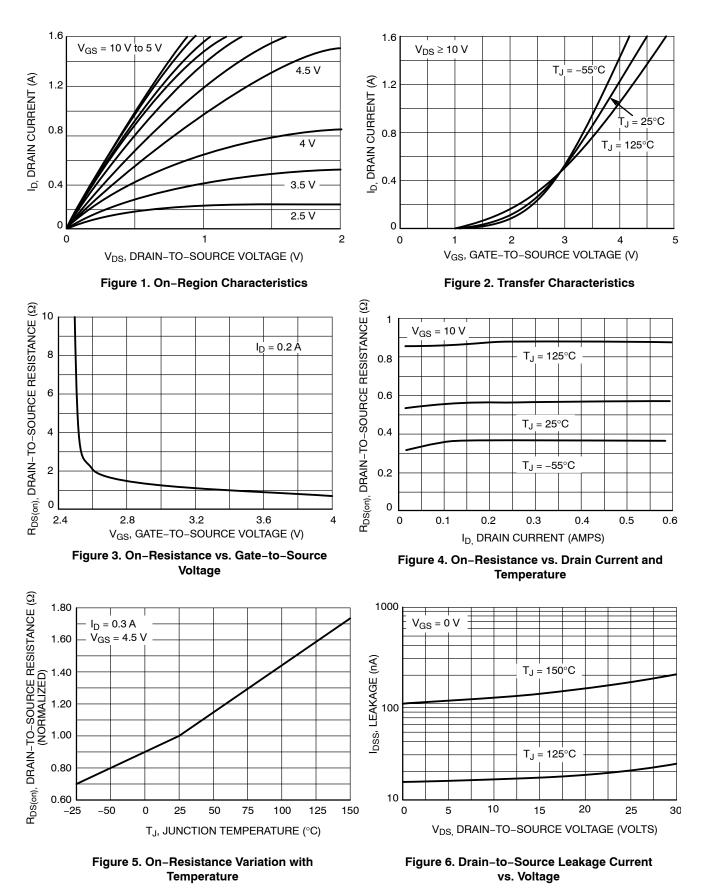
Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 100 \mu A$		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				40		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$\begin{array}{rcl} V_{GS} &=& 0 \ V, \\ V_{DS} &=& 30 \ V \end{array}$	$T_J = 25^{\circ}C$			1.0	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±10 V				±1.0	μΑ
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{E}$) = 250 μA	0.8		1.4	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.4		mV/°C
Drain-to-Source On Resistance	5	V_{GS} = 4.0 V, I _D = 10 mA			1.0	1.5	Ω
	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{\text{D}} = 10 \text{ mA}$			1.5	2.0	
Forward Transconductance	9 _{FS}	$V_{DS} = 3.0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}$			0.33		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}				21	42	
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 5.0 V			19.7	40	pF
Reverse Transfer Capacitance	C _{rss}	23			8.1	16	1
Total Gate Charge	Q _{G(TOT)}				1.15		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 5.0 V, V	DS = 24 V,		0.15		
Gate-to-Source Gate Charge	Q _{GS}	$I_{\rm D} = 0$.1 A		0.32		
Gate-to-Drain Charge	Q _{GD}				0.23		1
SWITCHING CHARACTERISTICS (Note	e 4)						
Turn-On Delay Time	t _{d(on)}				16.7		
Rise Time	tr	V_{GS} = 4.5 V, V_{DD} = 5.0 V, I _D = 0.1 A, R _G = 50 Ω			47.9		ns
Turn-Off Delay Time	t _{d(off)}				65.1		
Fall Time	t _f				64.2		
SOURCE-DRAIN DIODE CHARACTER	ISTICS						
Forward Diode Voltage Vs	V _{SD}	$V_{GS} = 0 V,$ $I_S = 10 mA$	$T_J = 25^{\circ}C$		0.65	0.7	V
			$T_J = 125^{\circ}C$		0.45		7
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, dI_S/dt = 8A/\mu s,$			14		ns

 $I_{\rm S} = 10 \,\mathrm{mA}$ Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



TYPICAL PERFORMANCE CURVES (T_J = 25° C unless otherwise noted)

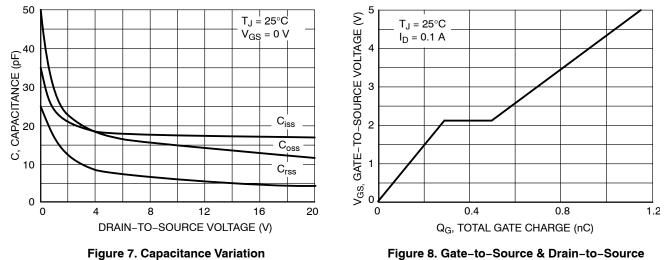


Figure 8. Gate-to-Source & Drain-to-Source Voltage vs. Total Charge

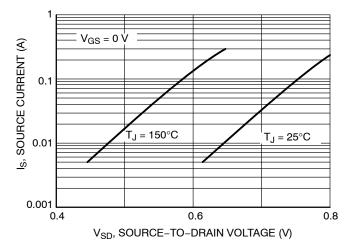
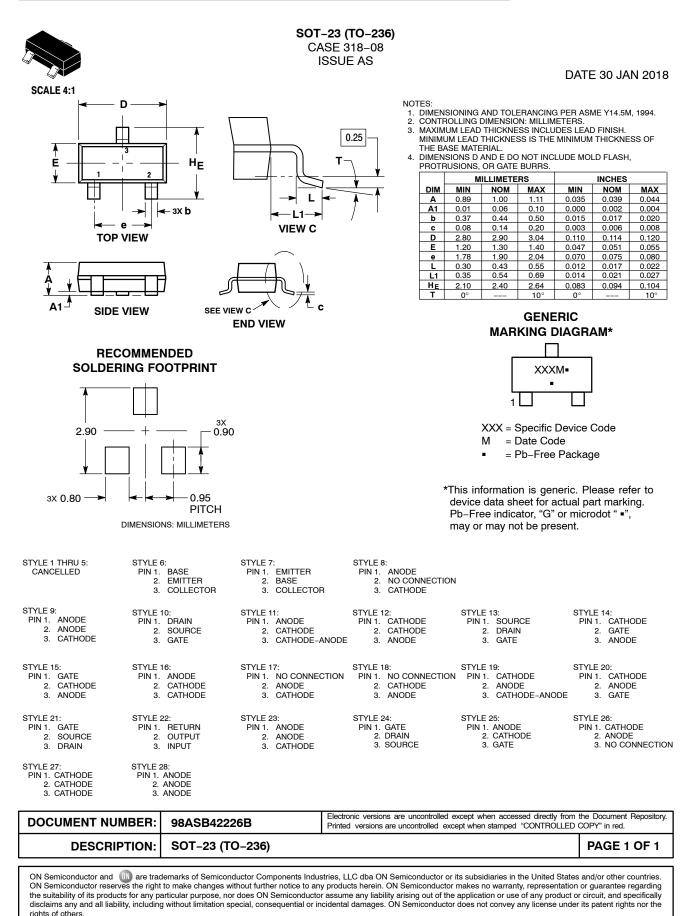


Figure 9. Diode Forward Voltage vs. Current





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